

# MOS FIELD EFFECT TRANSISTOR NP100P06PLG

# **SWITCHING** P-CHANNEL POWER MOSFET

#### **DESCRIPTION**

The NP100P06PLG is P-channel MOS Field Effect Transistor designed for high current switching applications.

#### <R> ORDERING INFORMATION

PART NUMBER	LEAD PLATING	PACKING	PACKAGE	
NP100P06PLG-E1-AY Note		T 000	TO 000 (MD 057D)	
NP100P06PLG-E2-AY Note	Pure Sn (Tin)	Tape 800 p/reel	TO-263 (MP-25ZP)	

**Note** Pb-free (This product does not contain Pb in external electrode.)

#### **FEATURES**

Super low on-state resistance

 $R_{DS(on)1}$  = 6.0  $m\Omega$  MAX. (Vgs = -10 V, Ip = -50 A)

 $R_{DS(on)2} = 7.8 \text{ m}\Omega \text{ MAX}. \text{ (V}_{GS} = -4.5 \text{ V}, I_{D} = -50 \text{ A})$ 

• High current rating: ID(DC) = ∓100 A

• Built-in gate protection diode

#### ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (Vgs = 0 V)	VDSS	-60	V
Gate to Source Voltage (VDS = 0 V)	Vgss	∓20	V
Drain Current (DC) (Tc = 25°C)	I <sub>D(DC)</sub>	∓100	Α
Drain Current (pulse) Note1	I <sub>D(pulse)</sub>	∓300	Α
Total Power Dissipation (Tc = 25°C)	P <sub>T1</sub>	200	W
Total Power Dissipation (T <sub>A</sub> = 25°C)	P <sub>T2</sub>	1.8	W
Channel Temperature	Tch	175	°С
Storage Temperature	Tstg	-55 to +175	°C
Single Avalanche Current Note2	las	64	Α
Single Avalanche Energy Note2	Eas	420	mJ

**Notes 1.** PW  $\leq$  10  $\mu$ s, Duty Cycle  $\leq$  1%

2. Starting T<sub>ch</sub> = 25°C, V<sub>DD</sub> = -30 V, R<sub>G</sub> = 25  $\Omega$ , V<sub>GS</sub> =  $-20 \rightarrow 0$  V

#### THERMAL RESISTANCE

Channel to Case Thermal Resistance 0.75 °C/W Channel to Ambient Thermal Resistance 83.3 °C/W Rth(ch-A)

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(TO-263)

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The mark <R> shows major revised points.

Printed in Japan

The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

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# ELECTRICAL CHARACTERISTICS (TA = 25°C)

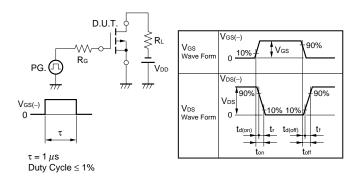
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	V <sub>DS</sub> = -60 V, V <sub>GS</sub> = 0 V			-10	μА
Gate Leakage Current	Igss	V <sub>GS</sub> = ∓20 V, V <sub>DS</sub> = 0 V			∓10	μΑ
Gate to Source Threshold Voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -1 mA	-1.0	-1.6	-2.5	V
Forward Transfer Admittance Note	yfs	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -50 A	43	86		S
Drain to Source On-state Resistance Note	RDS(on)1	V <sub>GS</sub> = -10 V, I <sub>D</sub> = -50 A		4.4	6.0	mΩ
	RDS(on)2	V <sub>GS</sub> = -4.5 V, I <sub>D</sub> = -50 A		5.0	7.8	mΩ
Input Capacitance	Ciss	V <sub>DS</sub> = -10 V,		15000		pF
Output Capacitance	Coss	V <sub>GS</sub> = 0 V,		1810		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		840		pF
Turn-on Delay Time	t <sub>d(on)</sub>	$V_{DD} = -30 \text{ V}, I_D = -50 \text{ A},$		28		ns
Rise Time	tr	V <sub>GS</sub> = -10 V,		35		ns
Turn-off Delay Time	td(off)	R <sub>G</sub> = 0 Ω		275		ns
Fall Time	tf			100		ns
Total Gate Charge	Q <sub>G</sub>	V <sub>DD</sub> = -48 V,		300		nC
Gate to Source Charge	Q <sub>GS</sub>	V <sub>GS</sub> = -10 V,		35		nC
Gate to Drain Charge	Q <sub>GD</sub>	I <sub>D</sub> = -100 A		85		nC
Body Diode Forward Voltage Note	V <sub>F(S-D)</sub>	I <sub>F</sub> = -100 A, V <sub>GS</sub> = 0 V		0.92	1.5	V
Reverse Recovery Time	trr	I <sub>F</sub> = -100 A, V <sub>GS</sub> = 0 V,		70		ns
Reverse Recovery Charge	Qrr	di/dt = –100 A/μs		135		nC

**Note** Pulsed test PW  $\leq$  350  $\mu$ s, Duty Cycle  $\leq$  2%

# TEST CIRCUIT 1 AVALANCHE CAPABILITY

# $V_{GS} = -20 \rightarrow 0 \text{ V}$ $V_{DD}$ $V_{DD}$

# TEST CIRCUIT 2 SWITCHING TIME



# TEST CIRCUIT 3 GATE CHARGE

$$\begin{array}{c|c}
D.U.T. \\
I_G = -2 \text{ mA} \\
\hline
\end{array}$$

$$\begin{array}{c|c}
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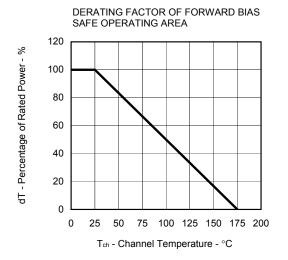
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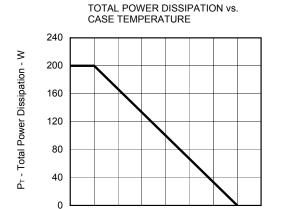
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$$\begin{array}{c|c}$$

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# TYPICAL CHARACTERISTICS (TA = 25°C)



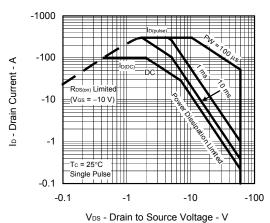


75 100 125 150 175 200

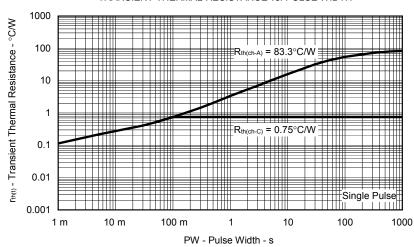
Tc - Case Temperature - °C

0 25 50

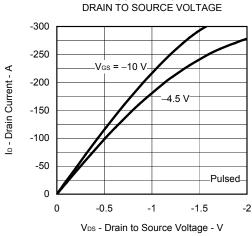
#### FORWARD BIAS SAFE OPERATING AREA



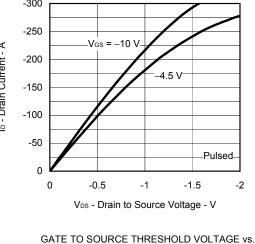
#### TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

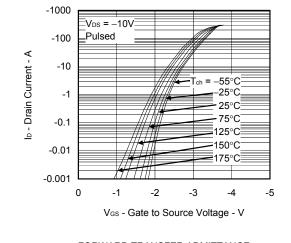


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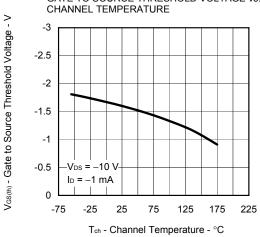


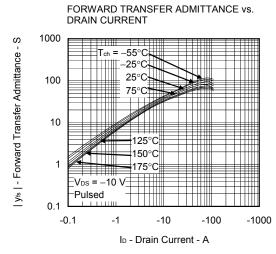
DRAIN CURRENT vs.

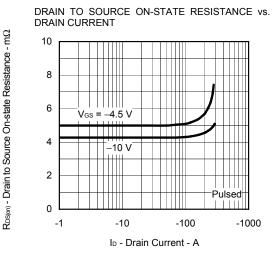


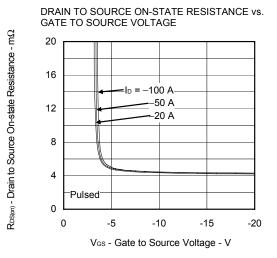


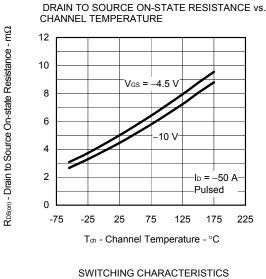
FORWARD TRANSFER CHARACTERISTICS

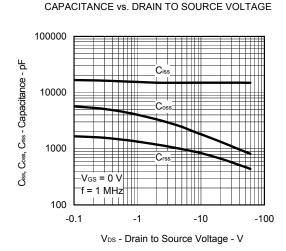


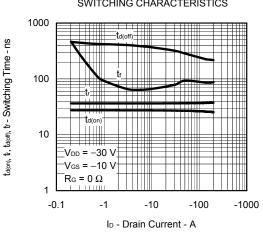


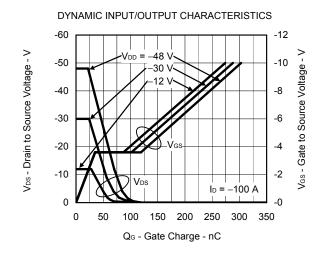


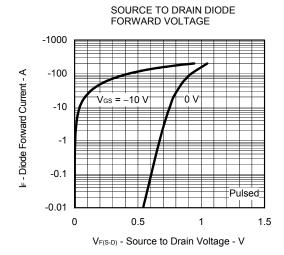


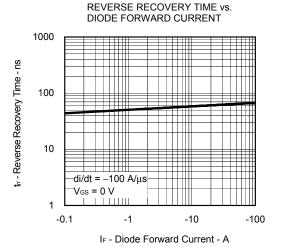








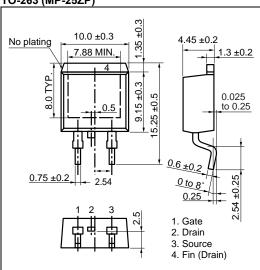




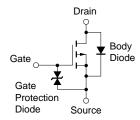
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# PACKAGE DRAWING (Unit: mm)

#### TO-263 (MP-25ZP)



#### **EQUIVALENT CIRCUIT**



**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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